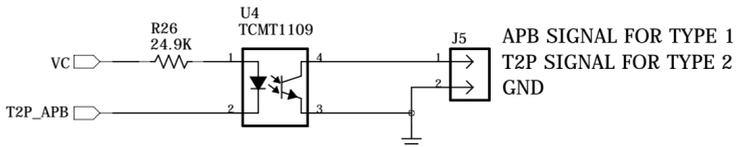
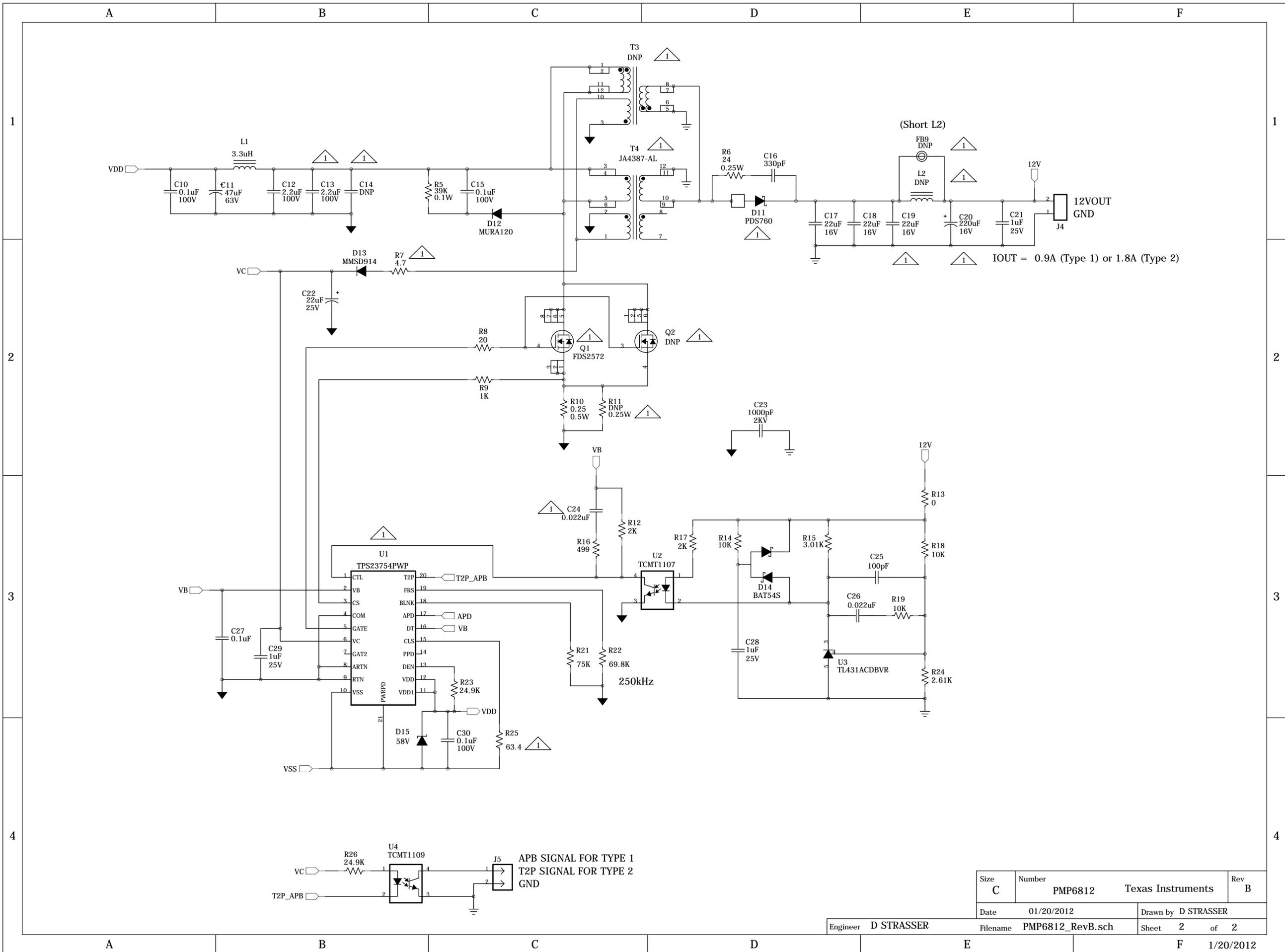


SCHEMATIC AS SHOWN IS FOR TYPE 2 CONVERTER
SEE BOM FOR TYPE 1 CONVERTER VALUES

Title TYPE 1 OR TYPE 2 POE CONVERTER, 12V OUT			
Size C	Number PMP6812	Texas Instruments	Rev B
Date 01/20/2012	Drawn by D STRASSER		
Engineer D STRASSER	Filename PMP6812_RevB.sch	Sheet 1	of 2



Size C	Number PMP6812	Texas Instruments	Rev B
Date	01/20/2012	Drawn by	D STRASSER
Engineer	D STRASSER	Filename	PMP6812_RevB.sch
		Sheet	2 of 2

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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
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